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Surface Mount Schottky Barrier Rectifier

FEATURES

- Ideal for automated placement
- Compact package size, profile <0.85mm
- High surge current capability
- Low power loss, high efficiency
- AEC-Q101 qualified and Halogen free only
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition











TYPICAL APPLICATIONS

The devices are designed for high frequency miniature switched mode power supplies such as adapters, lighting and on-board DC/DC converters.

MECHANICAL DATA

Case: SOD-123HE

Molding compound, UL flammability classification rating 94V-0

Base P/N with suffix "G" on packing code - green compound (halogen-free)

Base P/N with prefix "H" on packing code - AEC-Q101 qualified **Terminal:** Matte tin plated leads, solderable per JESD22-B102 with prefix "H" on packing code meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band **Weight:** 21mg (approximately)

		SS12	SS13	SS14	SS16	SS110	SS115	UNIT
PARAMETER	SYMBOL	LS	LS	LS	LS	LS	LS	
Marking code		12LS	13LS	14LS	16LS	10LS	A5LS	
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	60	100	150	V
Maximum RMS voltage	V_{RMS}	14	21	28	42	70	105	V
Maximum DC blocking voltage	V_{DC}	20	30	40	60	100	150	V
Maximum average forward rectified current	I _{F(AV)}	1				Α		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30			А			
Maximum instantaneous forward voltage @ 0.5 A (Note 1) @ 1.0 A	V _F	- 0.45	- 0.50	0.51 0.55	0.58 0.70	0.70 0.80	0.75 0.90	V
Maximum reverse current @ rated VR T _J =25 °C	,	0.4 0.05						
T _J =125 °C	I _R	-			0.5		mA	
Typical junction capacitance (Note 2)	C _J	80			pF			
Typical thermal resistance	$R_{ heta JC} \ R_{ heta JA}$	25 70			°C/W			
Operating junction temperature range	T _J	- 55 to +125 - 55 to +150					оС	
orage temperature range		- 55 to +150				оС		

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Measured at 1 MHz and Applied Reverse Voltage of 4.0V DC



ORDERING INFORMATION					
PART NO.	AEC-Q101	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING
	QUALIFIED		CODE		
SS1xxLS	Prefix "H"	RV	Suffix "G"	SOD-123HE	3,000 / 7" Reel
(Note 1, 2)		RQ	Guilla G	SOD-123HE	10,000 / 13" Reel

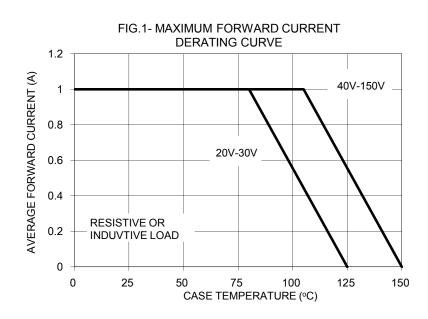
Note 1: "xx" defines voltage from 20V (SS12LS) to 150V (SS115LS)

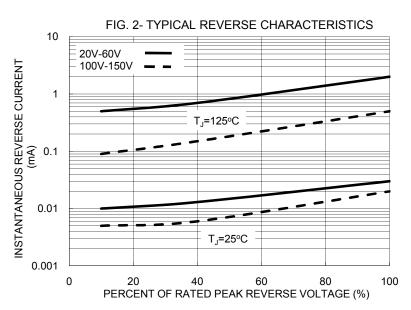
Note 2: Whole series with AEC-Q101 qualified and green compound (halogen-free)

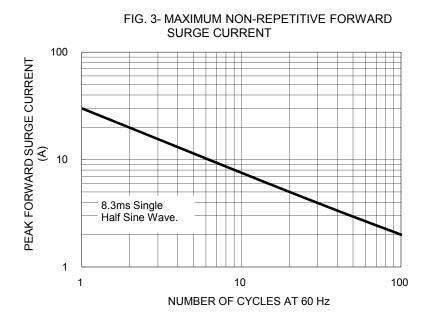
EXAMPLE					
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION
SS115LSHRVG	SS115LS	Н	RV	G	AEC-Q101 qualified Green compound

RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)







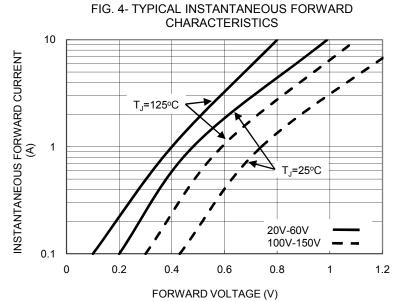
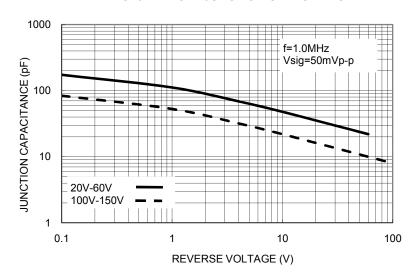


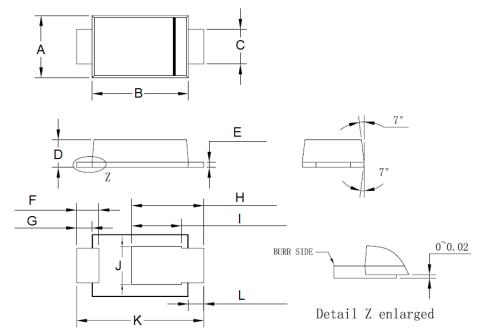


FIG. 5- TYPICAL JUNCTION CAPACITANCE



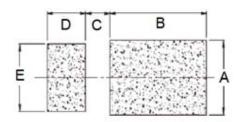
PACKAGE OUTLINE DIMENSIONS

SOD-123HE



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	1.65	1.95	0.065	0.077	
В	2.60	3.00	0.102	0.118	
С	0.85	1.15	0.033	0.045	
D	0.75	0.85	0.030	0.033	
Е	0.10	0.20	0.004	0.008	
F	0.55	0.75	0.022	0.030	
G	0.35	0.55	0.014	0.022	
Н	1.90	2.30	0.075	0.091	
I	1.35	1.55	0.053	0.061	
J	0.95	1.25	0.037	0.049	
K	3.50	3.90	0.138	0.154	
L	0.35	0.55	0.014	0.022	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.40	0.055
В	2.40	0.094
С	0.70	0.028
D	0.90	0.035
Е	1.40	0.055

MARKING DIAGRAM



P/N YW = Marking Code

V = Date Code

= Factory Code



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